

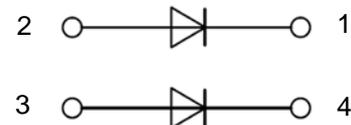
PRODUCT FEATURES

- Ultrafast Reverse Recovery Time
- Soft Reverse Recovery Characteristics
- Low Reverse Recovery Loss
- High System Power Density
- Popular SOT-227 Package



APPLICATIONS

- Inversion Welder
- Uninterruptible Power Supply
- Plating Power Supply
- Ultrasonic Cleaner and Welder
- Converter & Chopper
- PFC



ABSOLUTE MAXIMUM RATINGS ($T_C=25^{\circ}\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
V_R	Maximum D.C. Reverse Voltage		700	V
V_{RRM}	Maximum Repetitive Reverse Voltage			
$I_{F(AV)}$	Average Forward Current	$T_C=90^{\circ}\text{C}$, Per Diode	60	A
		$T_C=90^{\circ}\text{C}$, Per Module	120	
$I_{F(RMS)}$	RMS Forward Current	$T_C=90^{\circ}\text{C}$, Per Diode	84	
I_{FSM}	Non Repetitive Surge Forward Current	$T_J=45^{\circ}\text{C}$, $t=10\text{ms}$, Sine, peak value	600	
		$T_J=45^{\circ}\text{C}$, $t=8.3\text{ms}$, Sine, peak value	660	
I^2t	For Fusing	$T_J=45^{\circ}\text{C}$, $t=10\text{ms}$, Sine, peak value	1800	A ² S
		$T_J=45^{\circ}\text{C}$, $t=8.3\text{ms}$, Sine, peak value	1807	
P_D	Power Dissipation		208	W
T_J	Junction Temperature		-40 to +150	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range		-40 to +125	$^{\circ}\text{C}$
V_{isol}	Isolation Breakdown Voltage	AC, 50Hz(R.M.S), $t=1\text{minute}$	3000	V
Torque	Module to Sink	Recommended (M4)	0.7~1.1	Nm
Torque	Module Electrodes	Recommended (M4)	0.7~1.1	Nm
R_{thJC}	Junction to Case Thermal Resistance(Per Diode)		0.6	$^{\circ}\text{C}/\text{W}$
Weight			26.5	g

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MMF2X60J070D

ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions	Min.	Typ.	Max.	Unit
I_{RM}	Maximum Reverse Leakage Current	$V_R = 700\text{V}$		0.5	mA
		$V_R = 700\text{V}, T_J = 125^\circ\text{C}$		10	
V_F	Forward Voltage	$I_F = 60\text{A}$	1.15	1.5	V
		$I_F = 60\text{A}, T_J = 125^\circ\text{C}$		1.0	
t_{rr}	Reverse Recovery Time ($I_F = 1\text{A}, dI_F/dt = -200\text{A}/\mu\text{s}, V_R = 30\text{V}$)		50		ns
t_{rr}	Reverse Recovery Time		150		ns
I_{RRM}	Maximum Reverse Recovery Current		18		A
t_{rr}	Reverse Recovery Time		260		ns
I_{RRM}	Maximum Reverse Recovery Current		28		A

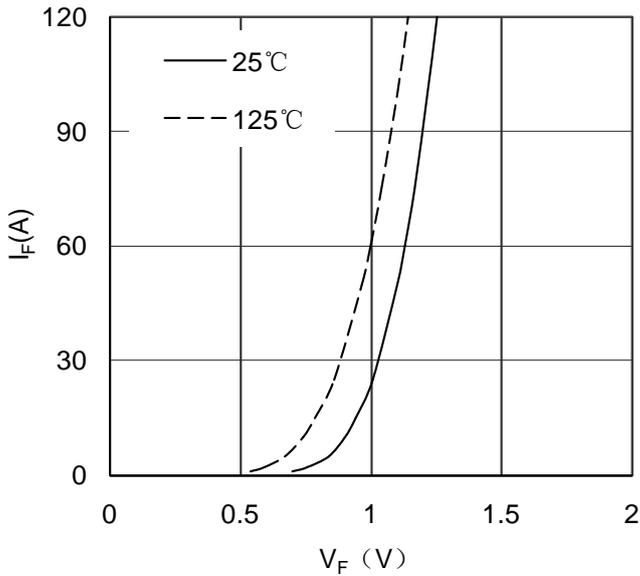


Figure 1. Forward Voltage Drop vs Forward Current

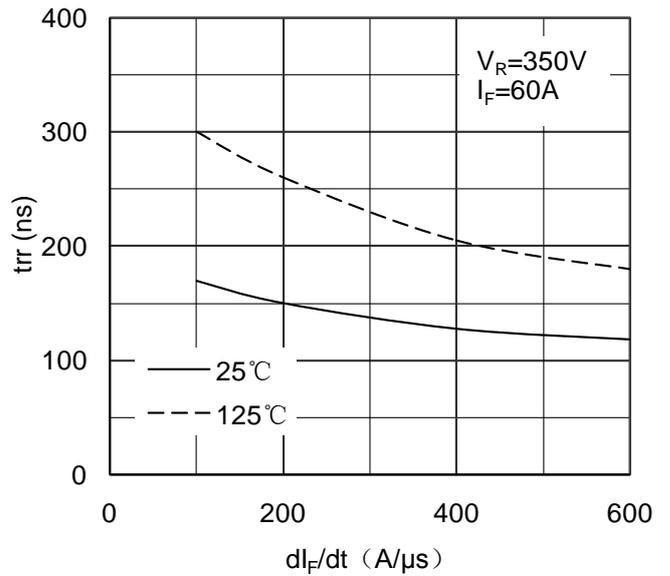


Figure 2. Reverse Recovery Time vs dI_F/dt

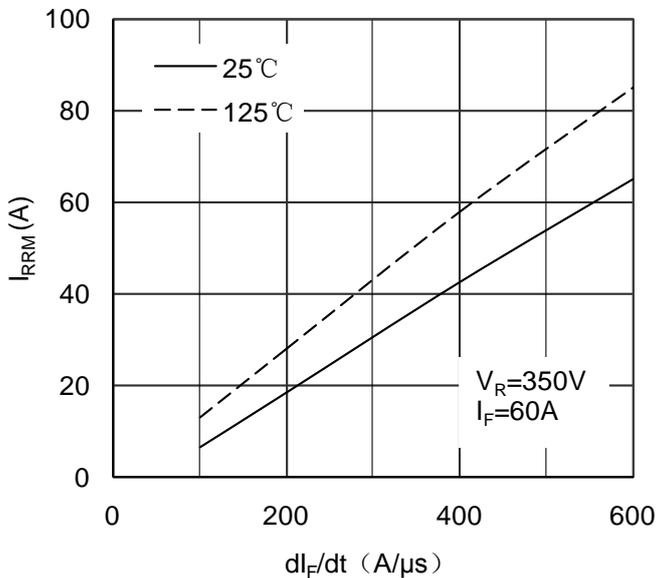


Figure 3. Reverse Recovery Current vs dI_F/dt

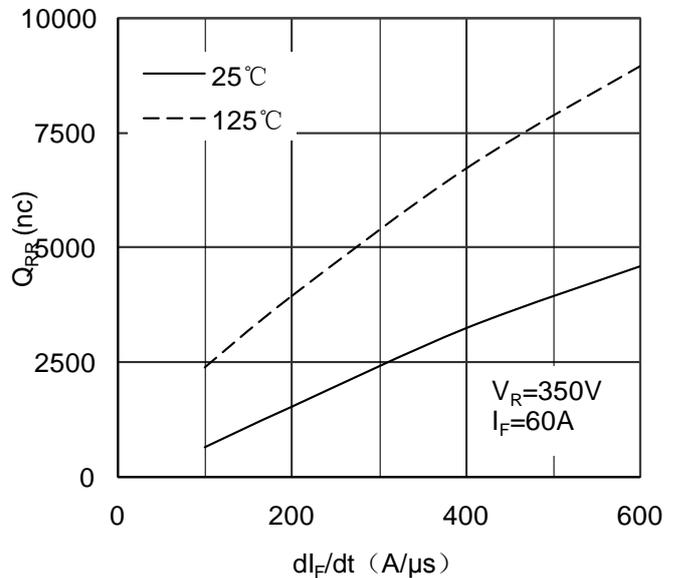


Figure 4. Reverse Recovery Charge vs dI_F/dt

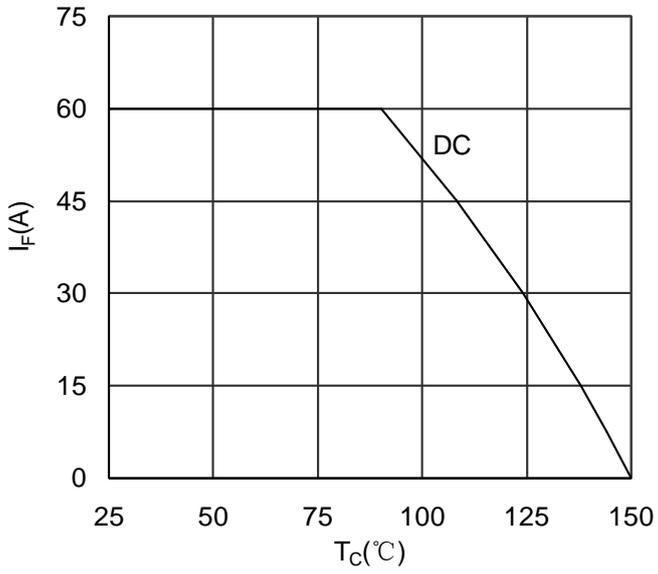


Figure 5. Forward current vs Case temperature

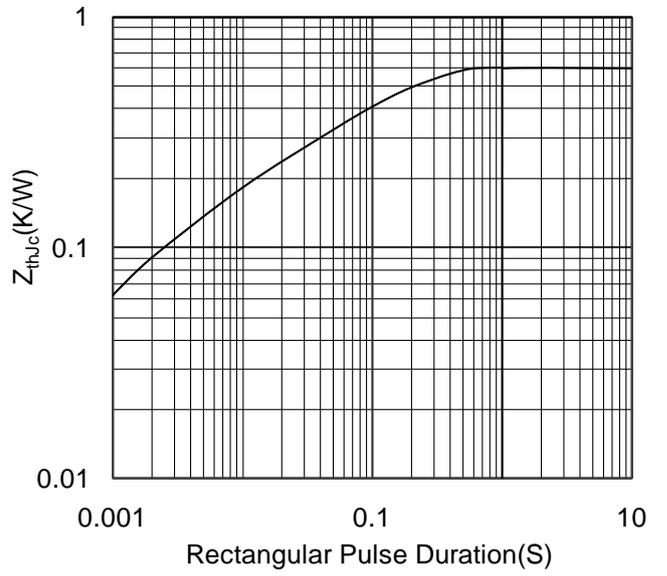
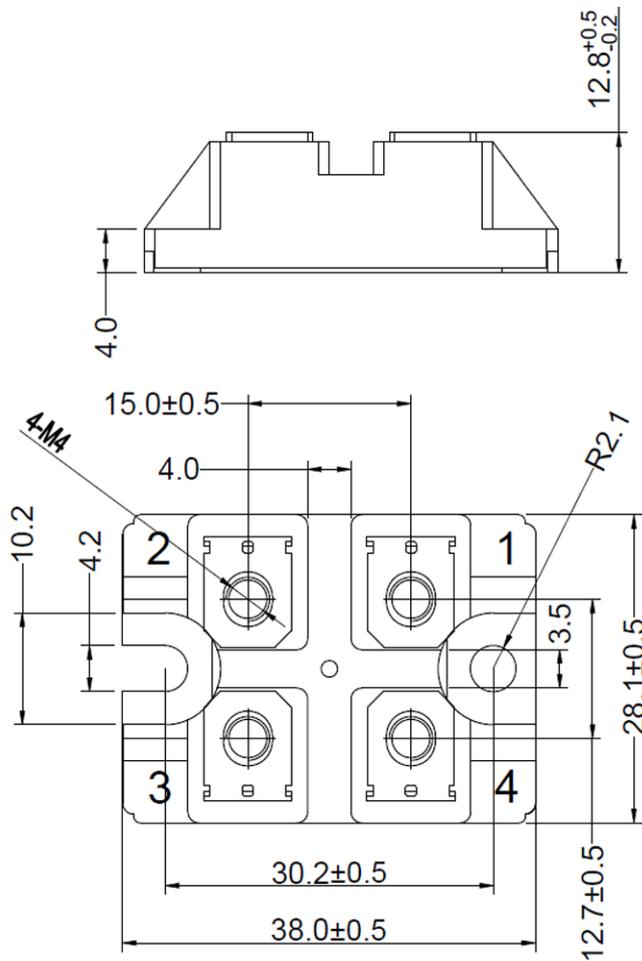


Figure 6. Transient Thermal Impedance



Dimensions in (mm)
Figure 7. Package Outline